

## **Excellent Integrated System Limited**

Stocking Distributor

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Panasonic Electronic Components EXB-24V510JX

For any questions, you can email us directly: sales@integrated-circuit.com



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	Issue No. : 151EXB008058
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DIGI-KEY CORPORATION	Classification: ■ New □ Changed

#### PF L

RODUCT SPECIFIC	CATION I	F <b>C</b>	OR APPROVA
Product Description : Chip Resistor Product Part Number : EXB24V*	r Array (RoHS Cor * * □X	npli	iance)
Country of Origin : JAPAN, CHIN Applications : Standard elec	NA, MALAYSIA ctronic equipment		
*If you approve this specification, please	fill in and sign the bel	ow a	and return 1 copy to us.
Approval No :			
Approval Date :			
Executed by :			
(signature)			
Title :			
Dept. :			
Circuit Components Business Unit	Prepared by	:	Engineering Section
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Phone: +81-776-56-8034	Authorized by Signature	:	F. Watanake
Fax : +81-776-56-3114	Name(Print)		T.Watanabe Manager of Engineering





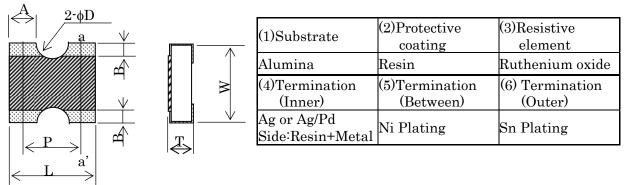
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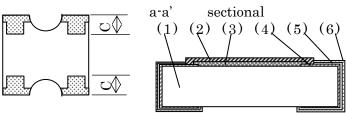
Datasheet of EXB-24V510JX - RES ARRAY 2 RES 51 OHM 0404

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Subject	Spec. No.
Chip Resistor Array PRODUCT SPECIFICATION FOR INFORMATION	151-EXB-24V01NE
Part No.	
EXB24V	8-1

#### 1. Dimension

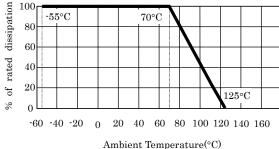




	L	W	Т	A	В
Dimension(mm)	1.00±0.10	1.00±0.10	0.35±0.10	$0.40\pm0.10$	$0.18\pm0.10$
	D	P	$\mathbf{C}$	():	Reference

	D	P	С	():R
Dimension(mm)	(0.30)	(0.65)	$0.25 \pm 0.10$	

#### 2. Power derating curve



125°C

Category temperature range

-55°C to +125°C

1

Fig. 1

#### 3. Ratings

Item	Rated Value Explanation			
Rated Dissipation	0.063 W / element	When used at ambient temperature over 70 °C, the rated dissipation should be reduced as shown in Fig.1		
	Chip jumper : Rated	l current 1 A (Resistance is less than 50 m $\Omega$ )		
Rated voltage & Rated Continuous	The rated voltage of each resistor should be calculated from the equation below, and when the rated voltage exceeds the limiting element voltage, the limiting element voltage should the maximum working voltage.			
Working Voltage (RCWV)	E = $\sqrt{P \times R}$ Limiting element voltage : 50 V E: Rated voltage(V), P: Rated dissipation(W), R: Rated resistance(Ω))			



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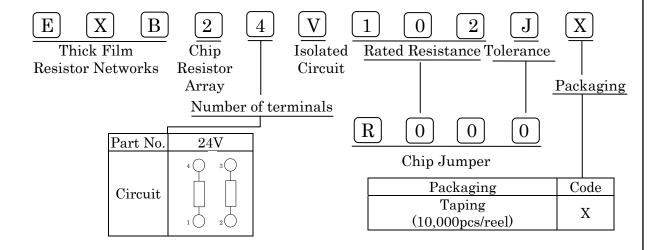
Datasheet of EXB-24V510JX - RES ARRAY 2 RES 51 OHM 0404

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Item	Rated Value	Explanation		
Maximum overload voltage	Voltage should be 2.5 × E. When the voltage exceeds the maximum overload voltage, the value shown below should be the maximum overload voltage.  Maximum overload voltage: 100V Chip jumper: Max. overload current 2A			
Resistance tolerance	Sign J 0	J ±5%		
Range of rated resistance for manufacture	Tolerance J 0	Resistance range $1.0~\Omega$ to $1.0~M\Omega$ Less than $50~m\Omega$	Series E-24	

### 4. Explanation of part number



### 5. Appearance & Construction

Item	Specifications	Explanation
Appearance & Construction	that do not fade easily flaw, pinhole and 2.The electrode sho dimensions. The unevenness, flav 3.The electrode sho resistive elemen	ould be printed uniformly, as shown in the plating should not fade easily, and should avoid w, pinhole, projection and discoloration. ould be connected electrically, mechanically to



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As far as there shall be not designation especially, the following test and measurement shall be operated under normal temperature(15 °C to 35 °C), normal humidity(25 %RH to 75 %RH), normal atmospheric pressure(86 kPa to 106 kPa).

### 6. Performance Specification

Item Specification		Test methods
Resistor	Jumper	1000 monous
		Measuring voltage: refer to JIS-C5201-1
within the specifi	ied tolerance	At 20 °C, 65 %RH
Resistance	TCR	Natural resistance change per temperature degree centigrade.
<10Ω	+600 ×10-6 / °C	$TCR = \frac{R_2 - R_1}{R_1 \times (t_2 - t_1)}$
$10\Omega$ to $1M\Omega$	±200×10 <sup>-6</sup> / °C	R <sub>1</sub> : Resistance value at reference
		$temperature(t_1)$
Chip jumper: Less than 50 mΩ		$R_2$ : Resistance value at test
		$temperature(t_2)$
		$t_2 - t_1 = 100 \text{ °C}, t_1 = 25 \text{ °C}$
Overload $\pm (2 \% + 0.1 \Omega)$ Less than $50 \text{ m}\Omega$		Resistors shall be applied 2.5 times the rated
		voltage for 5 seconds.
		Maximum over load voltage shall be 100 V.
		Resistors shall be subjected to 10000 cycles of
(7.0(.0.1.0)	Less than	2.5 times the rated voltage applied for 1
$\pm (5 \% + 0.1 \Omega)$	$50~\mathrm{m}\Omega$	second with pause of 25 seconds between
		tests.
NT 1 00	1	Maximum over load voltage shall be 100 V
		AC 100V between substrate and termination
		for 1 minute.
insulation breakdown.		
Min. 1,000 MΩ		Insulation resistance between substrate and
		termination shall be measured at DC 100V.
	Resistor  DC resistance within the specific Resistance $<10\Omega$ $10\Omega$ to $1M\Omega$ Chip jumper: Less that $\pm(2~\%+0.1~\Omega)$ No evidence of fluechanical dama insulation breakers	Resistor       Jumper         DC resistance value shall be within the specified tolerance         Resistance       TCR $<10\Omega$ $^{+600}_{-100} \times 10^{-6}$ / °C $10\Omega$ to $1M\Omega$ $\pm 200 \times 10^{-6}$ / °C         Chip jumper :       Less than $50 \text{ m}\Omega$ $\pm (2 \% + 0.1 \Omega)$ Less than $50 \text{ m}\Omega$ $\pm (5 \% + 0.1 \Omega)$ Less than $50 \text{ m}\Omega$ No evidence of flashover, mechanical damage, arcing or insulation breakdown.

#### 7. Mechanical characteristic

Item	Specification		Test methods
rtem	Resistor	Jumper	Test methods
Adhesion	No mechanical dar	nage	Load of 9.8N shall be applied to a side or resistor for 10s, which is placed on printing
Aunesion	±(1 %+0.05 Ω)	Less than 50 mΩ	board Printing board: Glass epoxy (t = 1.0 mm)
Bend strength of	ino inechanicai uamage		Substrate: Glass epoxy(t = 1.0 mm) Span: 90 mm
the face plating	±(1 %+0.05 Ω)	Less than 50 mΩ	Bending distance: 3 mm (10 seconds)
Solderability	uniformly with solder.		Resistors shall be dipped in the melted solder bath at 235 °C $\pm$ 5 °C for 2 s $\pm$ 0.5 s. Flux shall be removed from the surface of termination with clean organic solvent.



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Itom	Specification		Test methods	
Item	Resistor	Jumper	Test methods	
Resistance to	±(1 %+0.05 Ω)	Less than	Resistors shall be dipped in the melted solder	
soldering heat	±(1 /0+0.00 <u>22</u> )	$50~\mathrm{m}\Omega$	bath at $270  ^{\circ}\text{C} \pm 5  ^{\circ}\text{C}$ for $10\text{s} \pm 1\text{s}$ .	
Vibration	±(1 %+0.05 Ω)	Less than 50 mΩ	Resistors shall be subjected to a single vibration having as double amplitude of 1.5 mm for 2 hours in each three mutually perpendicular directions for total 6 hours. The vibration frequency shall be varied uniformly 10 Hz to 55 Hz and return to 10 Hz traversing for 1 minute.	
	Without distinct deformation in Solvent solution: Isopi		Solvent solution: Isopropyl alcohol	
	appearance		(1) Dipping 10 hours $\pm$ 1 hour, dry in room	
Solvent resistance	±(0.5 %+0.05 Ω)	Less than 50 mΩ	condition for 30 min ± 10 min.  (2) Ultrasonic wave washing: 5 min ± 1 min  (0.3 W/cm,28 kHz)  Dry in room condition for 30 min ± 10 min.	

### 8. Environmental Test

Item	Specification		Test methods	
rtem	Resistor	Jumper	Test methods	
Low temperature exposure	±(1 %+0.05 Ω)	Less than $50 \text{ m}\Omega$	Resistors shall be exposed at -55 °C $\pm$ 3 °C for 1000 hours $^{+48}_{0}$ hours	
Endurance at upper category temperature	±(1 %+0.05 Ω)	Less than 50 mΩ	Resistors shall be exposed at +125 °C±3 °C for 1000 hours $^{+48}_{0}$ hours.	
Temperature cycling	±(1 %+0.05 Ω)	Less than 50 mΩ	-55 °C ± 3 °C, 30 minutes ↑↓ Nominal temp., 30minutes 25cycles ↑↓ +125 °C ± 3 °C, 30minutes	
Humidity (Steady state)	±(1 %+0.05 Ω)	Less than 50 mΩ	Resistors shall be exposed at 60 °C $\pm$ 2 °C and 90 % to 95 % relative humidity in a humidity test chamber for 1000 hours $_{0}^{+48}$ hours.	
Endurance at 70 °C	±(3 %+0.1 Ω)	Less than 50 mΩ	Resistors shall be exposed at 70 °C $\pm$ 2 °C for 1000 hours $_0^{+48}$ hours. During this time, the rated voltage shall be applied intermittently for 1.5 hours ON, 0.5 hour OFF.	
Load life in humidity	±(3 %+0.1 Ω)	Less than 50 mΩ	Resistor shall be exposed at 60 °C $\pm$ 2 °C and 90 % to 95 % relative humidity for 1000 hours $_{0}^{+48}$ hours. During this time, the rated voltage shall be applied intermittently for 1.5 hours ON, 0.5 hour OFF.	

# 9. Resistance value marking No marking.



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#### 10. Notice for use



Notice for use

- (1) This specification shows the quality and performance of the product in a unit component. Before adoption, be sure to evaluate and verify the product mounting it in your product.
- (2)We take no responsibility for troubles caused by the product usage that is not specified in this specification.
- (3)In traffic transportation equipment (trains, cars, traffic signal equipment, etc.), medical equipment, aerospace equipment, electric heating appliances, combustion and gas equipment, rotating equipment, disaster and crime preventive equipment, etc. in cases where it is forecast that the failure of this product gives serious damage to human life and others, use fail-safe design and ensure safety by studying the following items to
  - Ensure safety as the system by setting protective circuits and protective equipment.
  - ◆ Ensure safety as the system by setting such redundant circuits as do not cause danger by a single failure.
- (4)When a dogma shall be occurred about safety for this product, be sure to inform us rapidly, operate your technical examination.
- (5) The product is designed to use in general standard applications of general electric equipment (AV products, household electric appliances, office equipment, information and communication equipment, etc.); hence, it do not take the use under the following special environments into consideration.

Accordingly, the use in the following special environments, and such environmental conditions may affect the performance of the product; prior to use, verify the performance, reliability, etc. thoroughly.

- 1) Use in liquids such as water, oil, chemical, and organic solvent.
- 2) Where the product is close to a heating component, or where an inflammable such as a polyvinyl chloride wire is arranged close to the product.
- 3) Where the product is sealed or coated with resin, etc.
- 4) Where water or a water-soluble detergent is used in cleaning free soldering (Pay particular attention to soluble flux.)
- 5) Use in such a place where the product is wetted due to dew condensation.
- 6) Use in places full of corrosive gases such as sea breeze, Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>X</sub>.
- 7) Use under direct sunlight, in outdoor or in dusty atmospheres.
- 8) Use in environment with large static electricity or strong electromagnetic waves.
- (6)If transient load (heavy load on a short time) like pulse is expected to be applied, carry out evaluation and confirmation test with resistors actually mounted on your own board. When the load of more than rated power is applied under the load condition at steady state, it may impair performance and/or reliability of resistor. Never exceed the rated power.

When the product shall be used under special condition, be sure to ask us in advance.

- (7)Halogen type (chlorine type, bromine type, etc.) or other high-activity flux is not recommended as the residue may affect performance or reliability of resistors.
- (8)When soldering with soldering iron, never touch the body of the chip resistor with a tip of the soldering iron. When using a soldering iron with a tip at high temperature, solder for a time as short as possible. (Three seconds or less up to 350 °C)
- (9) Avoid physical shock to the resistor and nipping of the resistor with hard tool (a pair of pliers or tweezers) as it may damage protective firm or the body of resistor and may affect resistor's performance.
- (10)Reflow soldering method shall apply to this product in principle.



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#### 11. Storage method

If the product is stored in the following environments and conditions, the performance and solderability may be badly affected. Avoid the storage in the following environments.

- (1) Storage in places full of corrosive gases such as sea breeze, Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>X</sub>.
- (2) Storage in places exposed to direct sunlight.
- (3) Storage in places outside the temperature range of 5  $^{\circ}$ C to 35  $^{\circ}$ C and humidity range of 45  $^{\circ}$ RH to 85  $^{\circ}$ RH.
- (4) Storage over a year after our delivery (This item also applies to the case where the storage method specified in item (1) to (3) has been followed.).

#### 12. Laws and Regulations

- (1) No ODCs or other ozone-depleting substances that are subject to regulation under the Montreal Protocol are used in our manufacturing processes, including in the manufacture of this product.
- (2) This product complies with the RoHS Directive (Restriction of the use of certain Hazardous Substances in electrical and electronic equipment (DIRECTIVE 2002/95/EC)).
- (3) All materials used in this product are existing chemical substances recognized under "lows on examination of chemical substances and regulations of manufacturing and others."
- (4) None of the materials used in this product contain the designated incombustible bromic substances, PBBOs and PBBs.
- (5) Please contact us to obtain a notice as to whether this product has passed inspection under review criteria primarily based on Foreign Exchange and Foreign Trade Control Laws, and appended table in the Export Control Laws.

#### 13. Production Place

Production Country : Japan

Production Plant : Panasonic Electronic Devices Japan Co., Ltd.

Production Country: China

Production Plant : Panasonic Electronic Devices (Tianjin) Co., Ltd.(PEDTJ)

Production Country: Malaysia

Production Plant : Panasonic Electronic Devices Malaysia Sdn. Bhd. (PEDMA)



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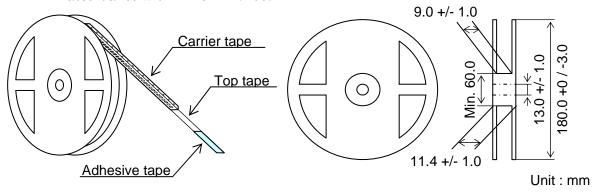
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#### 14. Tape and Reel Package

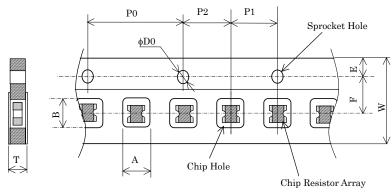
#### 14-1. Physical Dimensions

Structure and reel dimensions shall be as shown in the figure below.

Inaccordance with EIAJ ET-7200.



#### 14-2. Carrier Tape Dimensions



	A	В	W	F	E
(mm)	1.20±0.10	1.20±0.10	8.00±0.20	$3.50 \pm 0.05$	1.75±0.10

	P1	P2	P0	T	φD0
(mm)	2.00±0.10	$2.00 \pm 0.05$	4.00±0.10	$0.52 \pm 0.05$	$1.50^{+0.10}_{0}$

### 14-3. Specification

#### 14-3-1. Taping

(1) When the test shall be operated with the below conditions, peel strength should be 0.049N

to 0.49N, should not have flash and tear after peeling.



#### (2) Minimum Bending Radius

When carrier tape shall be bent by minimum bending radius (15 mm), no defection of chip and no break of carrier tape. However minimum bending radius shall be tested for 1 times.



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#### (3) Resistance to climate

When resistors shall be exposed at 60 °C  $\pm$  2 °C, 90 %RH to 95 %RH for 120 hours, no defection of chip and no break off carrier tape.

When the top tape shall be peeled, tape should not have flash and tear.

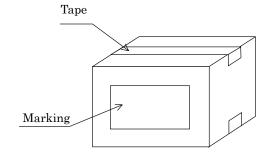
#### 14-3-2. Quantity in Taping: 10,000 pcs. / reel

#### 14-3-3. Tape packaging

- (1) Resistor side shall be facing upward.
- (2) Chip resistor shall not be sticking to top tape and bottom tape.
- (3) Chip resistors shall be easy to take out from carrier tape and chip hole or sprocket hole shall not have flash and break.

#### 14-4. Outer Packaging

Quantity: 20 reels(Max.200,000 pcs.)



- (1) When packaging quantity does not reach max quantity, the remaining empty space shall be buried with buffer material.
- (2) When quantity shall be few, alternative packaging methods may used. No problem must occur during the exportation of the product..

#### 14-5. Marking

At last, production country is displayed in English.

- Side of reel (Marking shall be on one side.)
  - (1)Part name (2)Part number (3)Quantity (4)Lot number (5)Maker name
  - (6)Production country
- •Packaging box
  - (1)Customer name (2)Part name (3)Part number (4)Customer part number
  - (5) Quantity (6) Maker name (7) Production country



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Subject	Spec. No.
Chip Resistor Array PRODUCT SPECIFICATION FOR INFORMATION	Attached Sheet
APPEARANCE QUALITY CRITERIA	1-1

			<b>'</b>
Item	Defect Criteria	Appearance Criteria	Remark
Resin Chipping		$A \le W/8$ $B \le C/2$	Both side chipping shall be judged defect
Terminal Chipping	Oblique line show chipping	$A \le C/4$ $B \le Top terminal width$	
Pin Hole	•	One pin hole / chip resistor $\phi \le 0.2 \text{ mm}$	This item is applied to pin holes which reach to the resistive materials
Flash	→   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   < A   →   	A ≤ 100 μm	